

## GloDroid

or boosting true open source Android stack development.



- 1. Introduction
- 2. Components selection
- 3. Graphic buffer allocation
- 4. Hardware composition
- 5. Audio configuration
- 6. Meson and Soong

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Pending



(Rockchip)



Khadas VIM3

## CLEAN AOSP v11rX (>700 repositories)

- 1. GloDroid device configuration repository
- 2. Mainline mesa3d fork + <u>14 patches</u>
- 3. Mainline **u-boot** fork + <u>17 patches</u>
- 4. Mainline drm\_hwcomposer fork + <u>1 patch</u>
- 5. Mainline **gbm\_fralloc** fork + <u>3 patches</u>
- 6. Mainline **tinyhal**
- 7. Mainline ATF

### Kernel:

- 8. Sunxi: integration branch from @megous mixed
- with Google kernel branch + <u>11 GloDroid patches</u>
- 9. Broadcom: Raspberry PI integration branch
- + Google patches, <u>0 GloDroid patches</u>.
- + Firmwares (6 repositories)
- + Linaro ARM compilers (3 repositories)
- + FOSS Applications repository (SkyTube, etc.)

## GloDroid components and mainlining status

## Current mesa3d "git log"

<u>s</u> .	74f9609318082	Fix v3d linking error
	a438de834ddd0	android: mesa: Move the FXT1 compressor/decompressor to util/
		android: egl: Implement EGL_KHR_swap_buffers_with_damage
	11556ea6af6ec	Revert "lima: use linear layout for shared buffers
es)		HACK: Support for Android-Q
53)	68a80844dbf57	[RFC] v3d: Use v3d with vc4 for kmsro.
	6ac46e9c167ce	vc4: Fix Android build
	24e38d311e8ac	v3d: Enable Android build
	512464b287b54	egl: android: add gbm_gralloc and drm_gralloc support
	39b24cdeb1de6	egl: android: add IMapper@4 metadata API buffer_info getter
	b58d86a5385d7	egl: android: prepare code for adding more buffer_info getters
	3a02a003c4e68	egl: android: use num_planes param in createImageFromDmaBufs()
		frontend/dri: add AR12 and AR15 format support
	a5d29cce84195	android: loader: convert Android.mk to Android.bp
	66fd9de6f5e81	mainline mesa3d
	7e77bfb68a9e4	





Sure.. Let's see... We need a development boards to train BSP engineers. Experts, can we use OrangePis from the kernel training program?

### **Engineer A**



Looks like no. HiKey is currently the only board that can be used for these purposes. OrangePis has only prebuilt Android images and we can't use them.

Ok, Then let's buy some HiKeys. But wait. It costs 250\$ each and they are no available on local market. We have to wait 2 months for arrival. Well, we have no choice, let's buy some.



Guys, are you sure there is no new Android BSP with open source for so popular Raspberry/Orange/BB boards we used before?





Looks really weird, Android is opensource and it is more then 10 years on the market. Why only closed ROMs are available for most of the boards? Let's do some quick investigation.

**Engineer B** 

Month later

I have good and bad news.

**Goon one:** I was able to flash AOSP system and vendor images built for HiKey to the OrangePi and board got booted and stuck at UI loading stage. **Bad news:** We do not have GPU GLES drivers for Android, SwiftShader crashes on 32bit ARM. Mesa3d software renderers are extremely slow (1FPS on single and 4FPS on multi-core implementations).

### 6 months later

MALI drivers are available in opensource domain and currently enters into mainline kernel and mesa3d as lima for MALI400-450 and panfrost for MALI MIDGARD and BIFROST. Let's try running Android with them in a free time.

### 9 months later

After fixing minor segfaults I've got LIMA working. UI still has some artifacts but overall performance is good enough. @Managers: Opensource portfolio is usually a good for the IT companies, Consider starting POC for bringing-up FOSS Android-BSP for OrangePis and other SBCs to the public domain.

Great news, Let's start the POC and motivate engineers to help us!



Sounds like a challenge:) I will do my best!

## Project goals:

Goal #1. Bring-up 100% open-source Android that can be downloaded and compiled using few shell commands.

Goal #2. Support most popular and accessible development platforms.

Goal #3. Be as close as possible to the mainline, so our project can be easily integrated with other up-to-date mainline-friendly components.

## Solutions:

## Solution for #1. Choose build system

Option A (current): Extend AOSP build system by creating custom rules.

Option B (may be the future): Create top-level build system (use yocto, etc.) and use AOSP as is. **Solution for #2.** 

Continuously do more research.

Different SOCs vendors have unique boot flow and driver set, different hardware acceleration features., etc. Common things should be combined and only differences should be described. **Solution for #3.** 

Find the appropriate components already available, choose the most advanced and up-to-date from the list, always contribute our experience back to the mainline.

## Top directives:

Do not change AOSP system part. Create only temporary forks of AOSP vendor part (to test or while waiting up-streaming). Reuse as much as possible from Linux world (ARMBIAN scripts, etc.)

## Limitations:

All above should be implemented considering constraints on available engineering resources for POCs in s/w service company (part-time assignments with low priority). Otherwise we are risking to slow down or completely stop.

**Solution:** Align the project with the company's interests: Leverage the POC for training/mentoring activities Start doing attempts to commercialize our work

## **Commercial world philosophies:**

1. All code should be kept proprietary, opening our work to the FOSS domain will reduce our advantages on the market.

2. Part of the code that isn't at cutting edge of the technologies can be open-sourced.

We won't lose anything. Our competitors do have already these features. However, we can reduce our own effort by sharing our work with community. Instead we can invest freed up time into increasing our competitive advantages by doing more innovative stuff.



## 2. Search for already available components



\*1. No opensouce mainline, only opensource snapshot available. Release cycle - 1 year.

T

Other...

?

GPU

GLES

impl.

Binary blob

from GPU

vendor

Software

via Google's

SwiftShader

Hardware

via

mesa3d

Linux

Kernel

Stable linux

kernel + Google

patches +

custom drivers

Stable linux

supported by

Google

Mainline linux

supported by

Google



## 3. New vision for graphic buffer allocation

- 1. Simplified AOSP Gralloc API
- 2. gbm\_gralloc
- 3. minigbm



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## Pros:

- 1. Simplicity combined with functionality.
- 2. Relying on linux-side development/test cycle

gbm gralloc

3. Any new driver in mesa3d will be supported out-of-the-box

## Cons:

- 1. Stuck at HAL@2.0, Android-10 require HALv3 Android-11 HALv4 for certification. Moreover HALv4 introduces metadata API which improves overall graphic stack.
- 2. Support for camera/video-encoder buffers isn't implemented.
- 3. Minimal community support
- 4. Long pass-through chain. Only mesa3d screen impl. does something really useful.

Selects correct optimizations based on many inputs: GPU family, type and usage flags: [SHARED, LINEAR, SCANOUT] **Optimizations example:** Use of lossless compression (Reduces load on memory bus) Use of tiling (Optimizes partial update and more) **Allocation area example:** Physically-contiguous memory Virtual memory



**Pros:** Latest frontend APIs, reduced code-path comparing to gbm\_gralloc, ChromeOS community support, included into the AOSP.

**Cons:** Duplication of optimizations selection code with mesa3d, which is **likely** not synced with mesa3d driver internals. No support for systems where buffers for display controller and buffers for GPU should be allocated in separate memory spaces. (CMA, VMEM). Limited driver support.

- Proposal #1: Implemented at : https://chromium-review.googlesource.com/c/chromiumos/platform/minigbm/+/2584842 Cons: To make pure-generic implementation significant part of additional logic must be copied from libmesagbm.so
- $^{\odot}$  Proposal #2: Should address cons from proposal 1.
  - Cons: No flexible per-device configuration.
- Proposal #3: Aims to address cons of proposals 1 and 2. Still slow code-path, is it really slow...?



## 4. Our architecture proposal for hardware-accelerated graphic compositor.

- 1. Simplified AOSP HWComposer2 API
- 2. drm\_hwcomposer project introduction
- 3. Proposal for structural redesign
- 4. Introduce component level planning
- 5. Improve DRM-level planning
- 6. Optimization

## HWComposer2 API









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improve GPU-offloading efficiency.







L - Layer S - Slot P - DRM planes I - Interface PF - Present fence WB - Writeback

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HWCOMPOSER

DROI

С С









## **Constraints:**

- **1**. Plane should support layer characteristics.
- 2. Plane can have fixed or floating ZPOS.

\* Per plane scaling support is not exposed via properties and should be detected in a different way.

DC - Display Controller WB - Writeback buffer (optional)

**DrmKmsPlan** struct { u8 SrcSlot: u8 DstPlane; u8 DstPlaneZpos;

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## Optimizations





## 5. XML-based audio configuration

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## 6. Meson to Soong bridge

- 1. Problem description
- 2. Solution proposal

### The problem:

1. Internally AOSP aims to support only Soong build system. This does mean any external component must be soong-compatible and must contain Android.bp file.

2. Currently AOSP can work with make-like (Android.mk) rules, but Google continuously restricts it and want to destage it some day.

3. Both **MESA3D** and **LIBCAMERA** project was initially created for linux and uses meson build system.

4. MESA3D project has set of Android.mks but it is not officially supported by maintainers and very soon became out-of-sync with Meson rules and require continuously fixing. Due to this out-of-sync nature, you can't build the project at every commit. You have to find working points or fix build manually. Bisect is almost impossible in this condition. In addition only limited set of drivers are available for build.

5. Soong build system can't be used by the software that require pre-generation of some of its parts.

## Solution #1 (Chromium OS way).

- Build the project externally using Android-NDK and ship it as a binary blob.

**Pros:** Already working for mesa3d and libcamera.

**Cons:** Require external build system. Can not be embedded into AOSP. NDK has limited API, for example using Mapper metadata API to get buffer parameters isn't possible yet.

## Solution #2 (Linaro/AOSP way).

- Manually adjust the rules, pre-generate required sources and put them together with original sources. Change Android.mk to use prebuilt sources.

**Pros:** Mesa3d can be embedded into the AOSP in source code form.

**Cons:** Each update require spending huge amount of work-hours. No bisect-ability and long upgrade cycle. Not mainline-friendly solution.

## Solution #3 (GloDroid way).

Add few hacks on top of mesa3d tree to overcome AOSP restrictions.
Pros: Only small difference with mainline is required (just a few code lines).
Cons: Having hacks is not best option. We are still relying on usually broken Android.mk.



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- 1. In case top-level build system exists it can trigger regeneration, so it is not necessary to store the pre-generated part.
- 2. For pure-AOSP integration regeneration must be triggered manually, so it is important to store pre-generated output in the repository (better to create separate repository for that).



# 

## THANK YOU

https://glodroid.github.io



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Chromium OS team Android-x86 team libcamera team

GloDroid external contributors: Sunxi platform contributor: Icenowy Zheng Amlogic platform contributor: Neil Armstrong FOSS Android HALs authors/contributors Rob Herring Sean Paul Richard Fitzgerald many other

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Other open source communities

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